

YETDA INDUSTRY LTD.

Technical Data Sheet

MODEL NO: 175UR/ANB4

0807Package 2.0*1.8mm Chip LEDs

Features:

•Package in 8mm tape on 7" diameter reel

•Compatible with automatic placement equipment

•Compatible with reflow solder process

Applications:

Indicators

•Automotive : backlighting in dashboard and switch

Backlight for LCD

| Dice material | Emitted color | Lens Color |
|---------------|---------------|-------------|
| AlGaInP | Red | |
| | | Water Clear |
| GalnN | Blue | |

Electrical/Optical Characteristics(Ta=25°C)

| Parameter | Test | Symbol | | Value | | l la it | |
|-----------------------------|-----------|------------------------|---|-------|-----|---------|--------|
| Parameter | Condition | | | Min | Тур | Max | - Unit |
| Wavelength at peak emission | lf=20mA | λ peak | R | | 640 | | - nm |
| | | | В | | 465 | | |
| Sportral half handwidth | lf=20mA | Δλ | R | | 20 | | - nm |
| Spectral half bandwidth | | | В | | 30 | | |
| Dominant wavelength | lf=20mA | λ dom | R | | 625 | | nm |
| Dominant wavelength | | | В | | 470 | | |
| | \/f | R | | 2.2 | 2.6 | V | |
| Forward voltage | lf=20mA | Vf | В | | 3.2 | 3.8 | V |
| | lf=20mA | lv | R | 80 | 120 | | - mcd |
| Luminous intensity | | | В | 40 | 60 | | |
| Viewing angle at 50% Iv | lf=10mA | 2 <i> </i> $	heta$ 1/2 | | | 140 | | Deg |
| Reverse current | Vr=5V | lr | | | | 10 | μA |

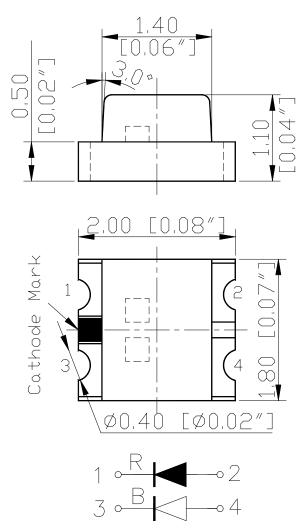


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Absolute Maximum Ratings(Ta=25°C)

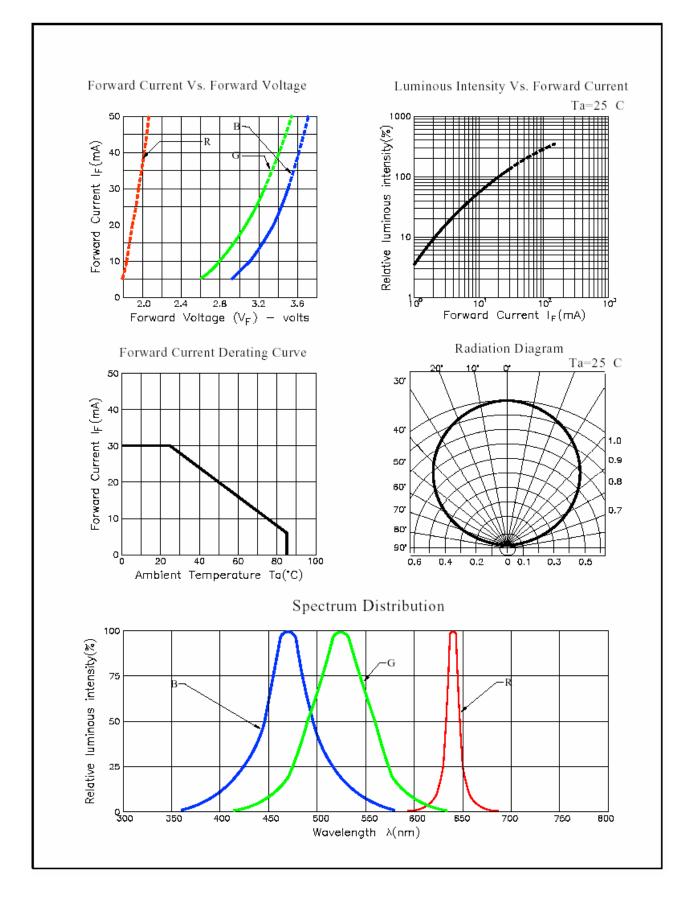
| Parameter | Symbol | Value | Unit |
|--|--------|----------|------|
| Power dissipation | Pd | 75 | mW |
| Forward current | lf | 30 | mA |
| Reverse voltage | Vr | 5 | V |
| Operating temperature range | Тор | -40 ~+80 | °C |
| Storage temperature range | Tstg | -40 ~+85 | °C |
| Peak pulsing current (1/8 duty f=1kHz) | lfp | 125 | mA |

PACKAGING DIMENSIONS (mm):



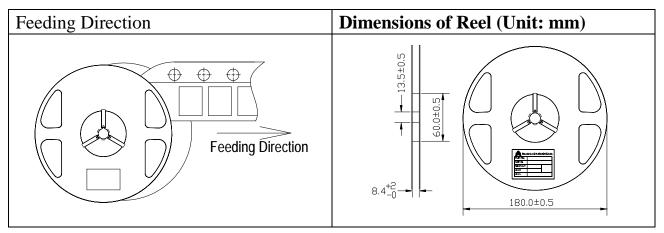


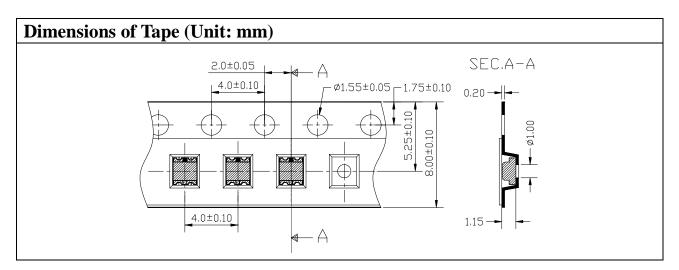
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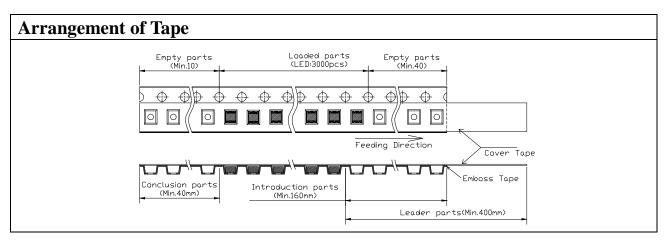




PACKAGING SPECIFICATIONS







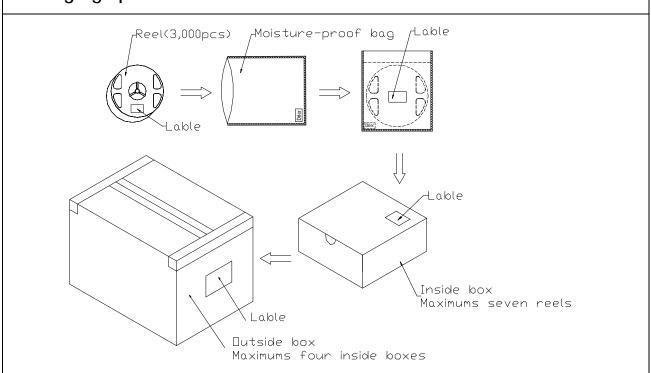
NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The polarity mark is oriented towards the tape sprocket hole ;
- 4. 3,000pcs/Reel.



PACKAGING SPECIFICATIONS

Packaging specifications



NOTES:

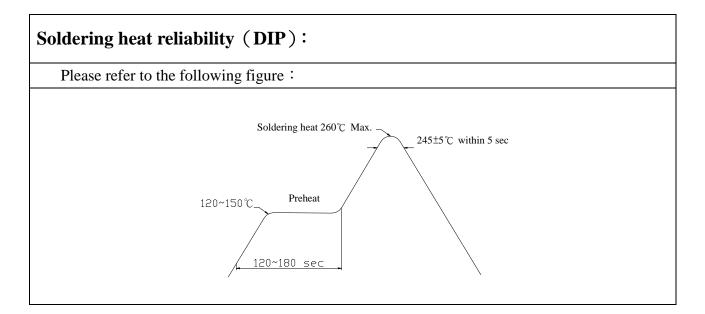
Reeled products (numbers of products are 3,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 21,000pcs) packed in an inside box (size: about 283mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.



Descriptions :

The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.

Besides, lightweight makes them ideal for miniature application, etc.



Precautions For Use :

Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

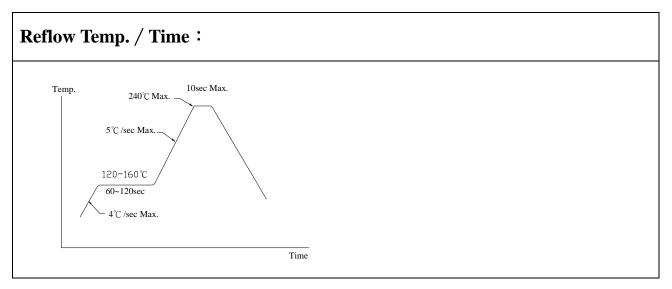
Storage

1. The operation of temperature and R.H. are : 5° C ~ 30° C , 60° K.H. Max.

- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is : $60^{\circ}C \pm 5^{\circ}C$ for 15hrs.







| Reliability Test Items And Conditions | | | | | | | |
|---------------------------------------|--|--|----------------------|----------------|--|--|--|
| The | reliability of products shal be satisfie | d with items listed below. | | | | | |
| No. | Items | Test Condition | Test Hours/Cycles | Sample Size | | | |
| 1 | Solder Heat | TEMP : 260° C $\pm 5^{\circ}$ C | 5 sec | 48 pcs | | | |
| 2 | Temperature Cycle | 90°C ~ 25°C ~ -30°C ~ 25 °C 30m 5m 30m 5m | 300Cycles | 48 Pcs | | | |
| 3 | Thermal Shick | 100°C ~ -55°C 10m 10m | 100Cycles | 48 Pcs | | | |
| 4 | Operation Life | If=20mA | 1000 Hrs | 48 Pcs | | | |
| 5 | High Temperature Storage | Temp:90°C | 1000Hrs | 48 Pcs | | | |
| 6 | Low Temperature Storage | Temp:-30°C | 1000Hrs | 48 Pcs | | | |
| 7 | High Temperature/High Humidity | 80°C / R.H80% | 1000Hrs | 48 Pcs | | | |